FUTURE PLANS

For a detailed description of our future plans, see "Business — Our Growth Strategies."

USE OF [REDACTED]

Assuming an [**REDACTED**] of HK$[**REDACTED**] per [**REDACTED**] (being the midpoint of the range of the [**REDACTED**] stated in this Document), we estimate that we will receive net [**REDACTED**] of approximately HK$[**REDACTED**] from the [**REDACTED**] after deducting the [**REDACTED**] commissions and other estimated expense in connection with the [**REDACTED**] (assuming the [**REDACTED**] is not exercised). We intend to use our [**REDACTED**] for the purposes and in the amounts set forth below.

- Approximately [**REDACTED**]% (HK$[**REDACTED**]) to invest in R&D for key technologies and core business. Specifically:
  - o approximately [**REDACTED**]% (HK$[**REDACTED**]) will be used over the next five to ten years to recruit, train and retain R&D talent, including campus hires and senior professionals, so as to further expand and upgrade our IP portfolio and adapt our IPs to AI-era application scenarios. In particular, we intend to iteratively optimize and enhance, among others, our GPGPU IP, AI-ISP IP, AI-DSP IP, AI-Video IP, AI-Display IP, high-speed interface IP, Die-to-Die interface IP for Chiplet-based architectures, wireless communication RF IP, automotive-grade IP, and ultra-low energy IP series for edge AI applications;
  - o approximately [**REDACTED**]% (HK$[**REDACTED**]) will be used over the next five to ten years to recruit, train and retain R&D talent, including campus hires and senior professionals, in order to: (1) extend our custom silicon platforms from cloud AI to edge AI deployments by developing and iterating custom silicon platforms for edge-side AI devices such as AI smartphones, AI PC, AI Pads, AI glasses, AI toys, AI rings, intelligent vehicles, robotics and other physical AI applications, as well as for digital therapeutics, braincomputer interface and other healthcare applications; and (2) extend our custom silicon platforms from SoC to SiP by developing and iterating Chiplet based platform architectures, and building advanced packaging engineering capabilities, to meet evolving heterogeneous computing and intelligent driving requirements;
  - o approximately [**REDACTED**]% (HK$[**REDACTED**]) will be used to procure R&D and engineering materials and equipment. Specifically, we intend to continue to purchase EDA tools, third-party IPs and other R&D related software; emulation, simulation and testing equipment; engineering wafers for R&D tape-outs etc;
  - o approximately [**REDACTED**]% (HK$[**REDACTED**]) will be used to invest in R&D centers, including the acquisition of office premises;
- Approximately [**REDACTED**]% (HK$[**REDACTED**]) will be used to further develop our global marketing network, expand and upgrade our regional sales and customer support capabilities, deepen cooperation with ecosystem partners in key segments, thereby further reinforcing our position in semiconductor industry value chain and our long-term sustainable development capabilities;

- Approximately [**REDACTED**]% (HK$[**REDACTED**]) will be used for strategic investments and/or acquisitions that are synergistic with our core business and enhance our IP portfolio, service offering and market access. We may selectively pursue minority investments, majority acquisitions or full integrations. The use of [**REDACTED**] may cover target evaluation, transaction execution and post-investment integration.

  As of the Latest Practicable Date, we have not identified any specific targets nor entered into any definitive agreements; deployment will be contingent upon valuation, diligence and regulatory approvals.

- Approximately [**REDACTED**]% (HK$[**REDACTED**]) for working capital and other general corporate purposes, including day-to-day operations and general corporate expenditures, to provide financial flexibility amid business growth.

The additional net [**REDACTED**] that we would receive if the [**REDACTED**] were exercised in full would be HK$[**REDACTED**]. In the event that the [**REDACTED**] is fixed at a higher or lower level compared to the midpoint of the range of the [**REDACTED**] stated in this Document, the net [**REDACTED**] from the [**REDACTED**] will be allocated to the above purposes on a pro rata basis.

In the event that certain parts of our development plans are hindered due to factors such as changes in government policies or force majeure events, our directors will carefully evaluate the situation and may reallocate the net [**REDACTED**] from the [**REDACTED**]. Should there be any significant changes to the intended use of [**REDACTED**], we will make appropriate disclosures in accordance with the Hong Kong Listing Rules.

To the extent that the net [**REDACTED**] of the [**REDACTED**] are not immediately used for the above purposes or if we are unable to effect any part of our future development plans as intended, we will only deposit such funds in short-term interest-bearing accounts at licensed commercial banks and/or other authorized financial institutions (as defined under the Securities and Futures Ordinance or applicable laws and regulations in other jurisdiction). In such event, we will comply with the appropriate disclosure requirements under the Hong Kong Listing Rules.